
HD74LV163A

Synchronous 4-bit Binary Counter (Synchronous Clear)

HITACHI

ADE-205-265B (Z)
3rd Edition
April 2000

Description

The HD74LV163A is 4-bit binary counters. All flip flops are clocked simultaneously on the low to high to transition (positive edge) of the clock input waveform. These counters may be preset using the load input. Presetting of all four flip flops is synchronous to the rising edge of clock. When load is held low counting is disabled and the data on the A, B, C and D inputs is loaded into the counter on the rising edge clock. If the load input is taken high before the positive edge of clock the count operation will be unaffected. Low-voltage and high-speed operation is suitable for the battery-powered products (e.g., notebook computers), and the low-power consumption extends the battery life.

Features

- $V_{CC} = 2.0\text{ V}$ to 5.5 V operation
- All inputs $V_{IH}(\text{Max.}) = 5.5\text{ V}$ ($@V_{CC} = 0\text{ V}$ to 5.5 V)
- All outputs $V_O(\text{Max.}) = 5.5\text{ V}$ ($@V_{CC} = 0\text{ V}$)
- Typical V_{OL} ground bounce $< 0.8\text{ V}$ ($@V_{CC} = 3.3\text{ V}$, $T_a = 25^\circ\text{C}$)
- Typical V_{OH} undershoot $> 2.3\text{ V}$ ($@V_{CC} = 3.3\text{ V}$, $T_a = 25^\circ\text{C}$)
- Output current $\pm 6\text{ mA}$ ($@V_{CC} = 3.0\text{ V}$ to 3.6 V), $\pm 12\text{ mA}$ ($@V_{CC} = 4.5\text{ V}$ to 5.5 V)

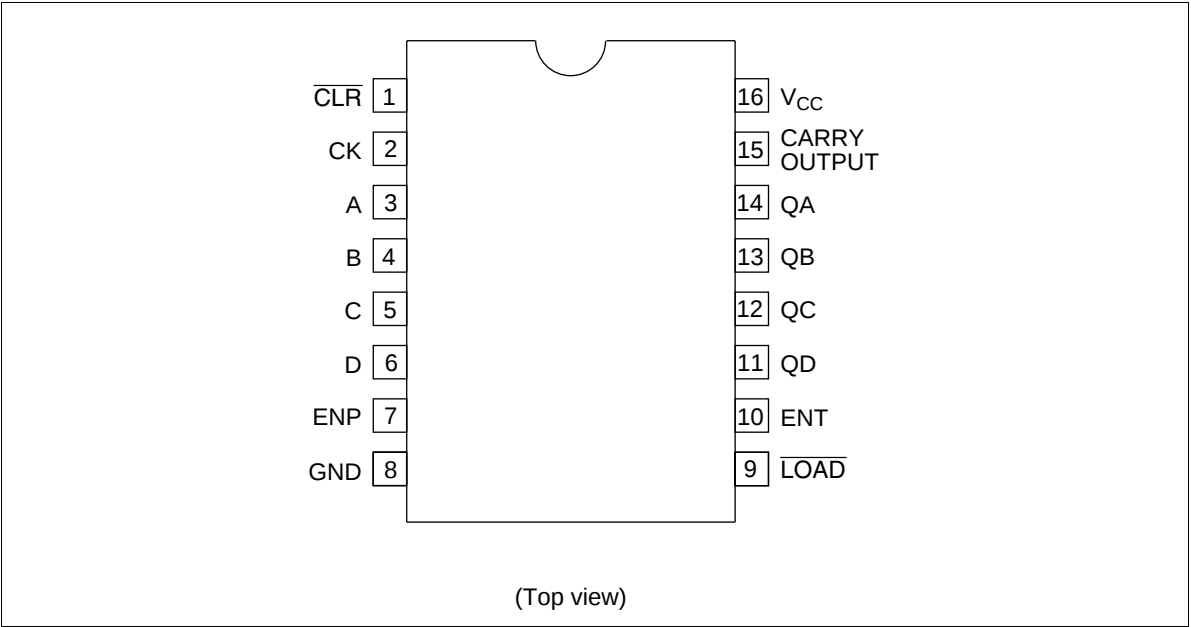
HD74LV163A

Function Table

Inputs					Outputs			
CLR	LOAD	ENP	ENT	CLK	QA	QB	QC	QD
L	X	X	X	↑	L	L	L	L
H	L	X	X	↑	A	B	C	D
H	H	X	L	↑	No change			
H	H	L	X	↑	No change			
H	H	H	H	↑	Count up			
X	X	X	X	↓	No change			

Note: H: High level
L: Low level
X: Immaterial
↑: Low to high transition
↓: High to low transition
A, B, C, D: Data input
Carry = ENT • QA • QB • QC • QD

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V_{CC}	−0.5 to 7.0	V	
Input voltage range* ¹	V_I	−0.5 to 7.0	V	
Output voltage range* ^{1, 2}	V_O	−0.5 to $V_{CC} + 0.5$ −0.5 to 7.0	V	Output: H or L V_{CC} : OFF
Input clamp current	I_{IK}	−20	mA	$V_I < 0$
Output clamp current	I_{OK}	±50	mA	$V_O < 0$ or $V_O > V_{CC}$
Continuous output current	I_O	±25	mA	$V_O = 0$ to V_{CC}
Continuous current through V_{CC} or GND	I_{CC} or I_{GND}	±50	mA	
Maximum power dissipation at $T_a = 25^{\circ}\text{C}$ (in still air)* ³	P_T	785 500	mW	SOP TSSOP
Storage temperature	T_{stg}	−65 to 150	°C	

Notes: The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

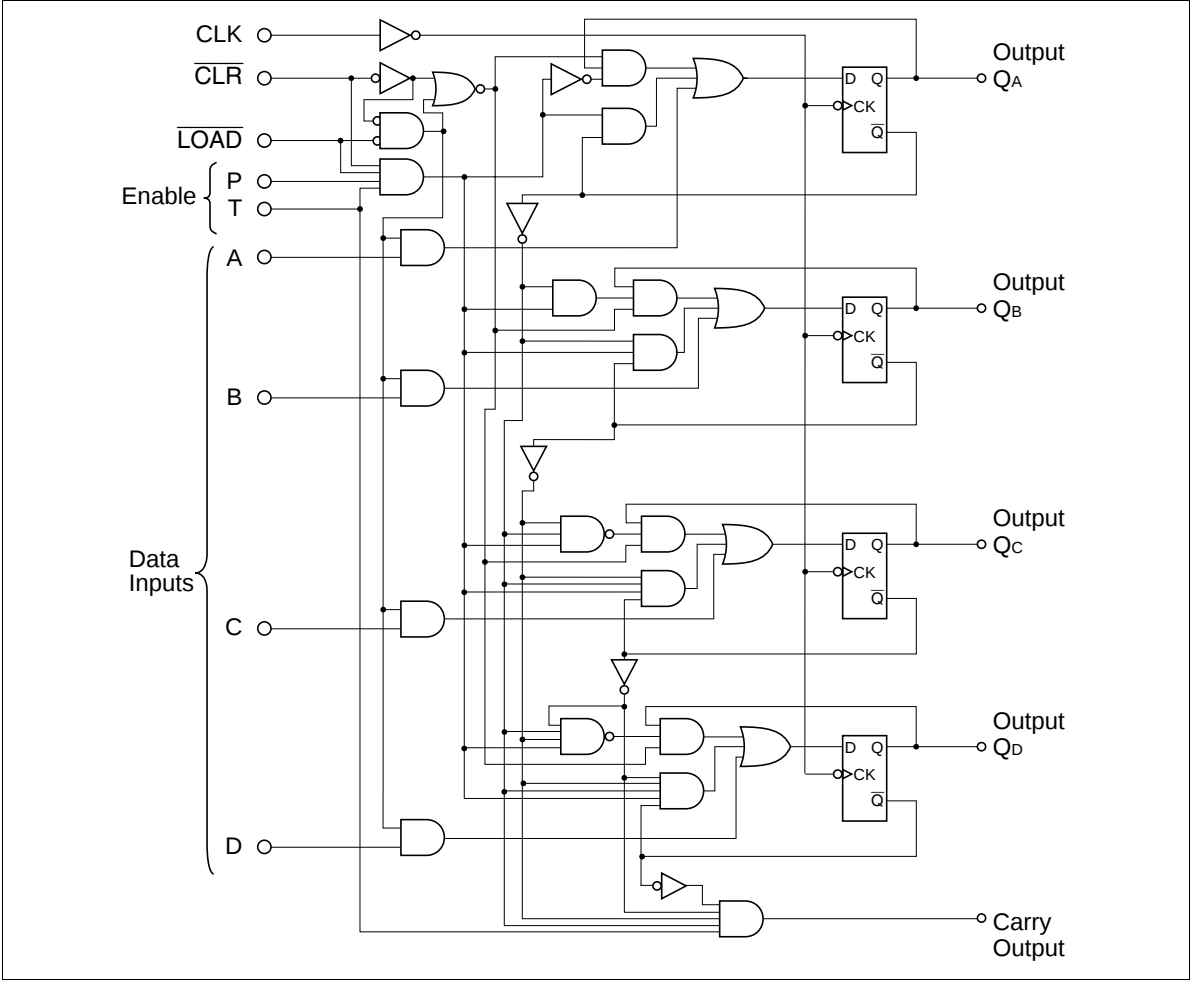
- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

Recommended Operating Conditions

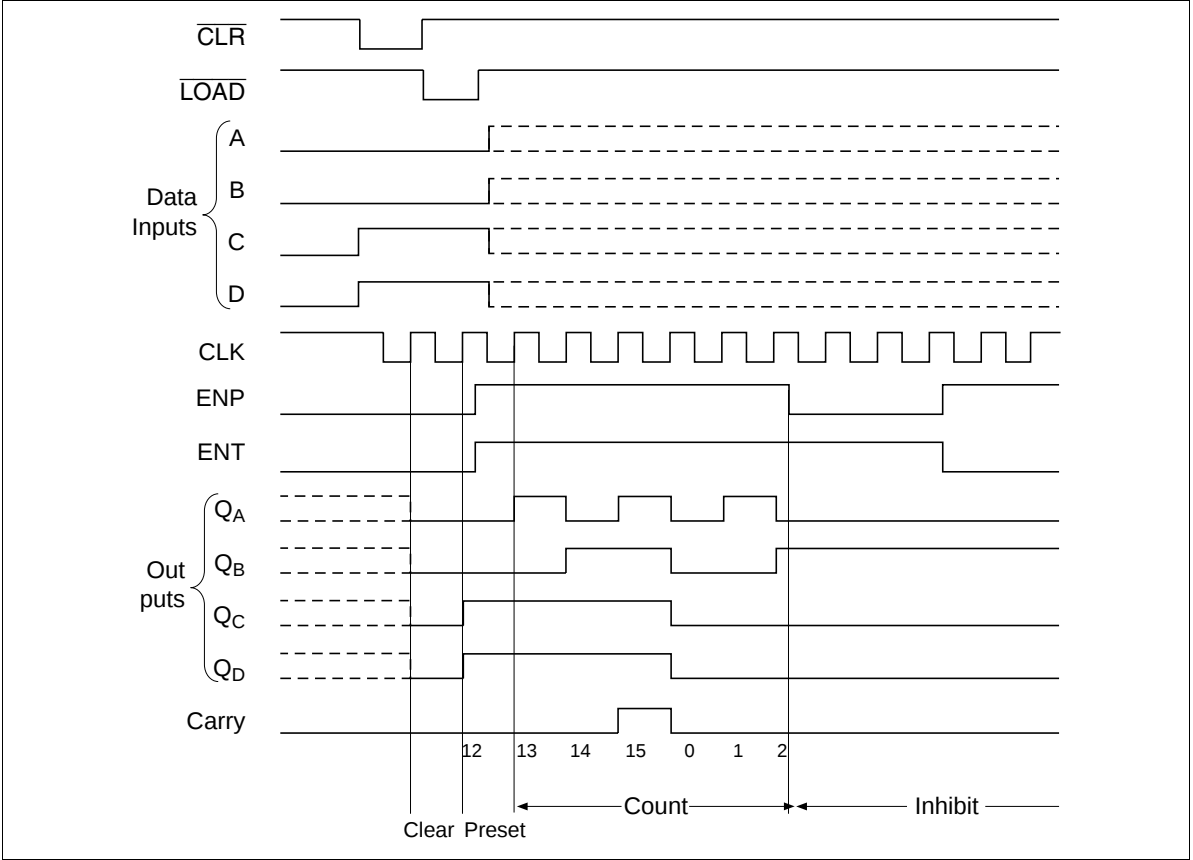
Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V _{CC}	2.0	5.5	V	
Input voltage range	V _I	0	5.5	V	
Output voltage range	V _O	0	V _{CC}	V	H or L
Output current	I _{OH}	—	−50	μA	V _{CC} = 2.0 V
		—	−2	mA	V _{CC} = 2.3 to 2.7 V
		—	−6		V _{CC} = 3.0 to 3.6 V
		—	−12		V _{CC} = 4.5 to 5.5 V
	I _{OL}	—	50	μA	V _{CC} = 2.0 V
		—	2	mA	V _{CC} = 2.3 to 2.7 V
		—	6		V _{CC} = 3.0 to 3.6 V
		—	12		V _{CC} = 4.5 to 5.5 V
Input transition rise or fall rate	Δt / Δv	0	200	ns/V	V _{CC} = 2.3 to 2.7 V
		0	100		V _{CC} = 3.0 to 3.6 V
		0	20		V _{CC} = 4.5 to 5.5 V
Operating free-air temperature	Ta	−40	85	°C	

Note: Unused or floating inputs must be held high or low.

Logic Diagram



Timing Diagram



DC Electrical Characteristics

• Ta = -40 to 85°C

Item	Symbol	V _{CC} (V)*	Min	Typ	Max	Unit	Test Conditions
Input voltage	V _{IH}	2.0	1.5	—	—	V	
		2.3 to 2.7	V _{CC} × 0.7	—	—		
		3.0 to 3.6	V _{CC} × 0.7	—	—		
		4.5 to 5.5	V _{CC} × 0.7	—	—		
	V _{IL}	2.0	—	—	0.5		
		2.3 to 2.7	—	—	V _{CC} × 0.3		
		3.0 to 3.6	—	—	V _{CC} × 0.3		
		4.5 to 5.5	—	—	V _{CC} × 0.3		
Output voltage	V _{OH}	Min to Max	V _{CC} - 0.1	—	—	V	I _{OL} = -50 µA
		2.3	2.0	—	—		I _{OL} = -2 mA
		3.0	2.48	—	—		I _{OL} = -6 mA
		4.5	3.8	—	—		I _{OL} = -12 mA
	V _{OL}	Min to Max	—	—	0.1		I _{OL} = 50 µA
		2.3	—	—	0.4		I _{OL} = 2 mA
		3.0	—	—	0.44		I _{OL} = 6 mA
		4.5	—	—	0.55		I _{OL} = 12 mA
Input current	I _{IN}	0 to 5.5	—	—	±1	µA	V _{IN} = 5.5 V or GND
Quiescent supply current	I _{CC}	5.5	—	—	20	µA	V _{IN} = V _{CC} or GND, I _O = 0
Output leakage current	I _{OFF}	0	—	—	5	µA	V _O = 5.5 V
Input capacitance	C _{IN}	3.3	—	1.7	—	pF	V _I = V _{CC} or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

- $V_{CC} = 2.5 \pm 0.2 \text{ V}$

		Ta = 25°C			Ta = −40 to 85°C				FROM	TO
Item	Symbol	Min	Typ	Max	Min	Max	Unit	Test Conditions	(Input)	(Output)
Maximum clock frequency	fmax	50	90	—	40	—	MHz	C _L = 15 pF		
		30	60	—	25	—		C _L = 50 pF		
Propa- gation delay time	t _{PLH} /t _{PHL}	—	11.1	16.2	1.0	19.5	ns	C _L = 15 pF	CLK	Q
		—	14.3	19.2	1.0	22.5		C _L = 50 pF		
	t _{PLH} /t _{PHL}	—	11.5	17.0	1.0	20.5	C _L = 15 pF	CLK	Carry	
	Count mode	—	14.7	20.0	1.0	23.5				C _L = 50 pF
	t _{PLH} /t _{PHL}	—	13.8	20.6	1.0	24.5	C _L = 15 pF	CLK	Carry	
	Load mode	—	17.0	23.6	1.0	27.5	C _L = 50 pF			
	t _{PLH} /t _{PHL}	—	10.3	15.7	1.0	19.0	C _L = 15 pF	ENT	Carry	
	—	14.0	18.7	1.0	22.0	C _L = 50 pF				
Setup time	t _{su}	7.5	—	—	8.5	—	ns		Data before CLK ↑	
		10.0	—	—	11.5	—			$\overline{\text{LOAD}}$ before CLK ↑	
		9.5	—	—	11.0	—			ENT, ENP before CLK ↑	
		6.0	—	—	6.0	—			$\overline{\text{CLR}}$ before CLK ↑	
Hold time	t _h	1.5	—	—	1.5	—	ns			
		1.5	—	—	1.5	—			$\overline{\text{CLR}}$ after CLK ↑	
Pulse width	t _w	7.0	—	—	7.0	—	ns		CLK H or L	

Switching Characteristics (cont)

- $V_{CC} = 3.3 \pm 0.3 \text{ V}$

Item	Symbol	Ta = 25°C			Ta = −40 to 85°C		Unit	Test Conditions	FROM (Input)	TO (Output)
		Min	Typ	Max	Min	Max				
Maximum clock frequency	t _{max}	80	130	—	70	—	MHz	C _L = 15 pF		
		55	85	—	50	—		C _L = 50 pF		
Propa- gation delay time	t _{PLH} /t _{PHL}	—	8.3	12.8	1.0	15.0	ns	C _L = 15 pF	CLK	Q
		—	10.8	16.3	1.0	18.5		C _L = 50 pF		
	t _{PLH} /t _{PHL}	—	8.7	13.6	1.0	16.0		C _L = 15 pF	CLK	Carry
	Count mode	—	11.2	17.1	1.0	19.5		C _L = 50 pF		
	t _{PLH} /t _{PHL}	—	11.0	17.2	1.0	20.0		C _L = 15 pF	CLK	Carry
	Load mode	—	13.5	20.7	1.0	23.5		C _L = 50 pF		
	t _{PLH} /t _{PHL}	—	7.5	12.3	1.0	14.5		C _L = 15 pF	ENT	Carry
		—	10.5	15.8	1.0	18.0		C _L = 50 pF		
Setup time	t _{su}	5.5	—	—	6.5	—	ns		Data before CLK ↑	
		8.0	—	—	9.5	—			LOAD before CLK ↑	
		7.5	—	—	9.0	—			ENT, ENP before CLK ↑	
		4.0	—	—	4.0	—			CLR before CLK ↑	
Hold time	t _h	1.0	—	—	1.0	—	ns			
		1.0	—	—	1.0	—			CLR after CLK ↑	
Pulse width	t _w	5.0	—	—	5.0	—	ns		CLK H or L	

Switching Characteristics (cont)

- $V_{CC} = 5.0 \pm 0.5 \text{ V}$

		Ta = 25°C			Ta = −40 to 85°C				FROM (Input)	TO (Output)
Item	Symbol	Min	Typ	Max	Min	Max	Unit	Test Conditions		
Maximum clock frequency	t _{max}	135	185	—	115	—	MHz	C _L = 15 pF		
		95	125	—	85	—		C _L = 50 pF		
Propa- gation delay time	t _{PLH} /t _{PHL}	—	4.9	8.1	1.0	9.5	ns	C _L = 15 pF	CLK	Q
		—	8.7	10.1	1.0	11.5		C _L = 50 pF		
	t _{PLH} /t _{PHL}	—	4.9	8.1	1.0	9.5	C _L = 15 pF	CLK	Carry	
	Count mode	—	6.4	10.1	1.0	20.0	C _L = 50 pF			
	t _{PLH} /t _{PHL}	—	6.2	10.3	1.0	12.0	C _L = 15 pF	CLK	Carry	
	Load mode	—	7.7	12.3	1.0	14.0	C _L = 50 pF			
	t _{PLH} /t _{PHL}	—	4.9	8.1	1.0	9.5	C _L = 15 pF	ENT	Carry	
	—	6.4	10.1	1.0	11.5	C _L = 50 pF				
Setup time	t _{su}	4.5	—	—	4.5	—	ns		Data before CLK ↑	
		5.0	—	—	6.0	—			LOAD before CLK ↑	
		5.0	—	—	6.0	—			ENT, ENP before CLK ↑	
		3.5	—	—	3.5	—			CLR before CLK ↑	
Hold time	t _h	1.0	—	—	1.0	—	ns			
		1.5	—	—	1.5	—			CLR after CLK ↑	
Pulse width	t _w	5.0	—	—	5.0	—	ns		CLK H or L	

Operating Characteristics

- $C_L = 50\text{ pF}$

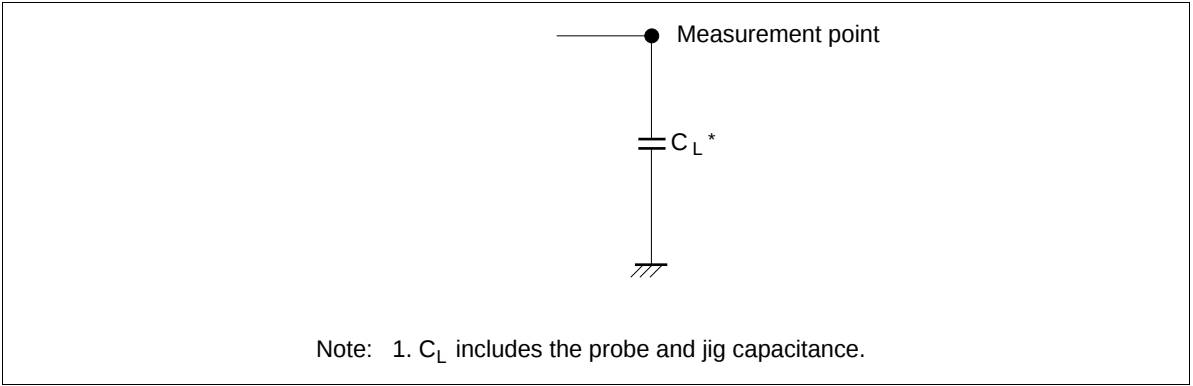
Item	Symbol	$V_{CC}\text{ (V)}$	$T_a = 25^\circ\text{C}$			Unit	Test Conditions
			Min	Typ	Max		
Power dissipation capacitance	C_{PD}	3.3	—	17.3	—	pF	$f = 10\text{ MHz}$
		5.0	—	20.6	—		

Noise Characteristics

- $C_L = 50\text{ pF}$

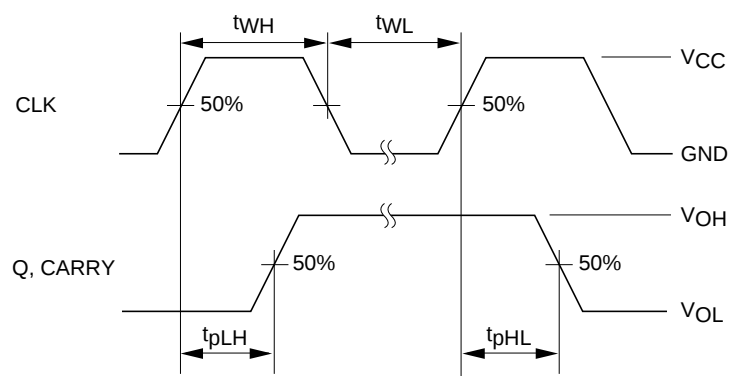
Item	Symbol	$V_{CC}\text{ (V)}$	$T_a = 25^\circ\text{C}$			Unit	Test Conditions
			Min	Typ	Max		
Quiet output, maximum dynamic V_{OL}	$V_{OL(P)}$	3.3	—	0.3	0.8	V	
Quiet output, minimum dynamic V_{OL}	$V_{OL(V)}$	3.3	—	−0.3	−0.8		
Quiet output, minimum dynamic V_{OH}	$V_{OH(V)}$	3.3	—	3.0	—		
High-level dynamic input voltage	$V_{IH(D)}$	3.3	2.31	—	—	V	
Low-level dynamic input voltage	$V_{IL(D)}$	3.3	—	—	0.99		

Test Circuit

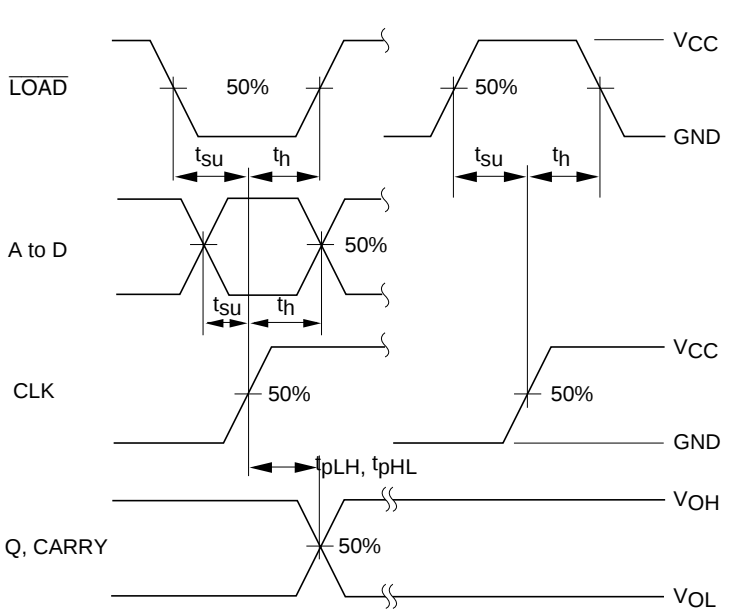


Waveform

Waveform – 1
Count mode

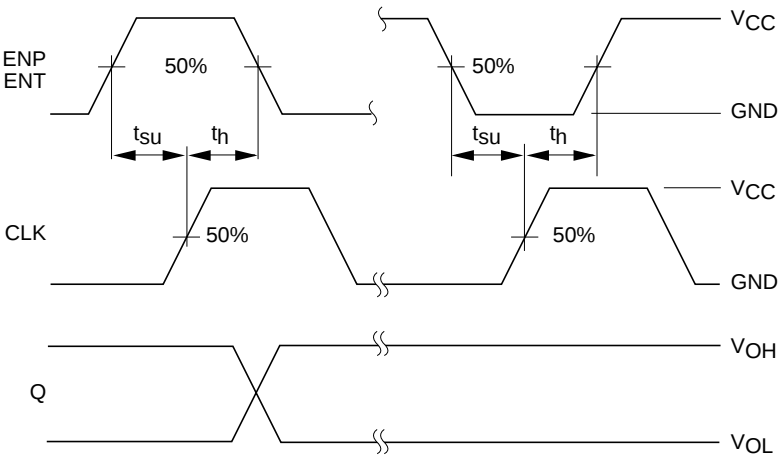


Waveform – 2
Preset mode



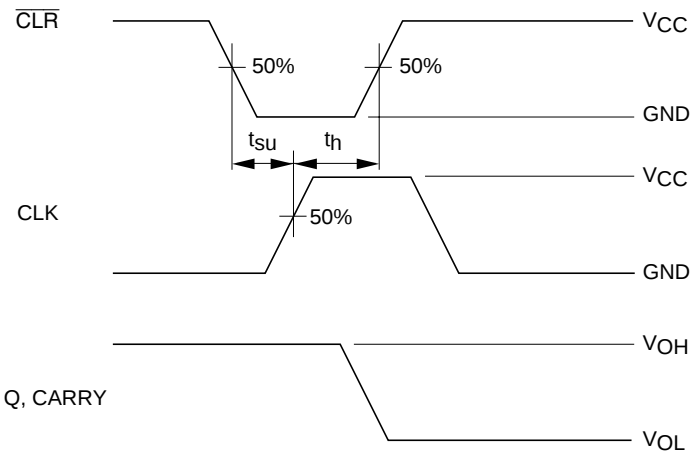
Waveform – 3

Count enable mode



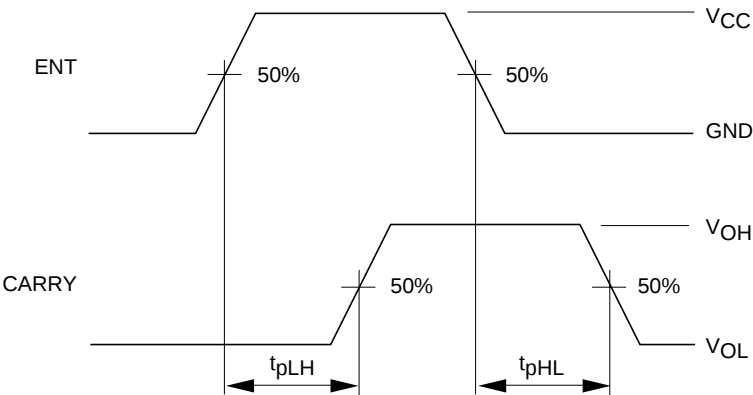
Waveform – 4

Clear mode



Waveform – 5

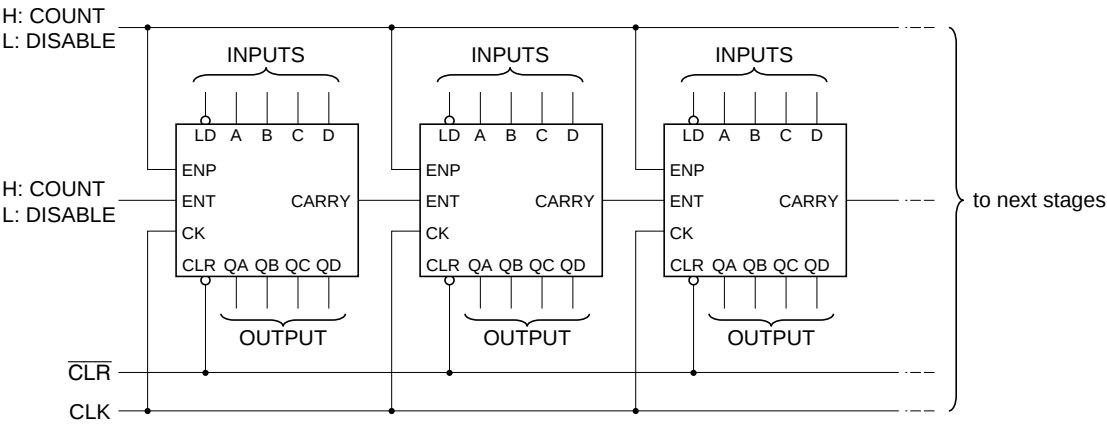
Cascade mode
(set to maximum count number)



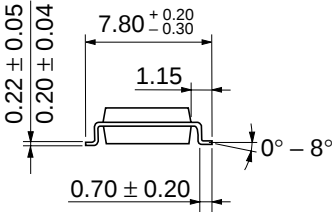
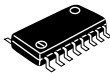
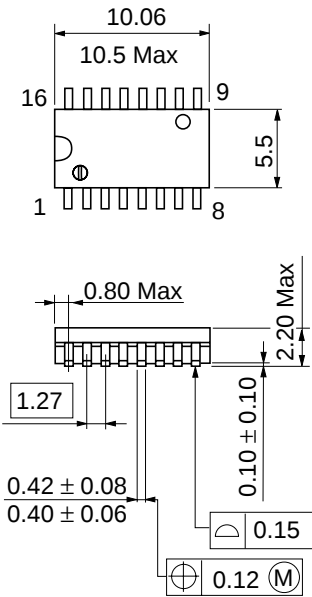
Note: 1. Input waveform: PRR≤1 MHz, duty cycle 50%, t_r ≤3 ns, t_f ≤3 ns

Application

Cascade circuitry



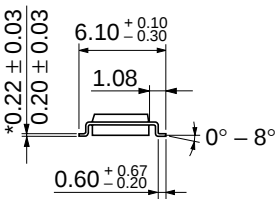
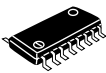
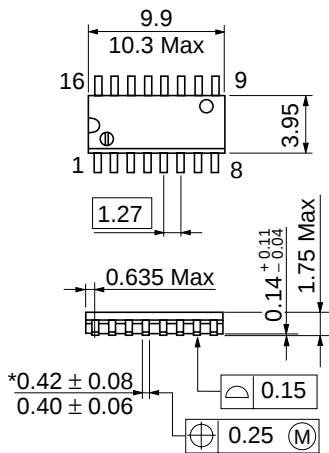
Package Dimensions



Dimension including the plating thickness
Base material dimension

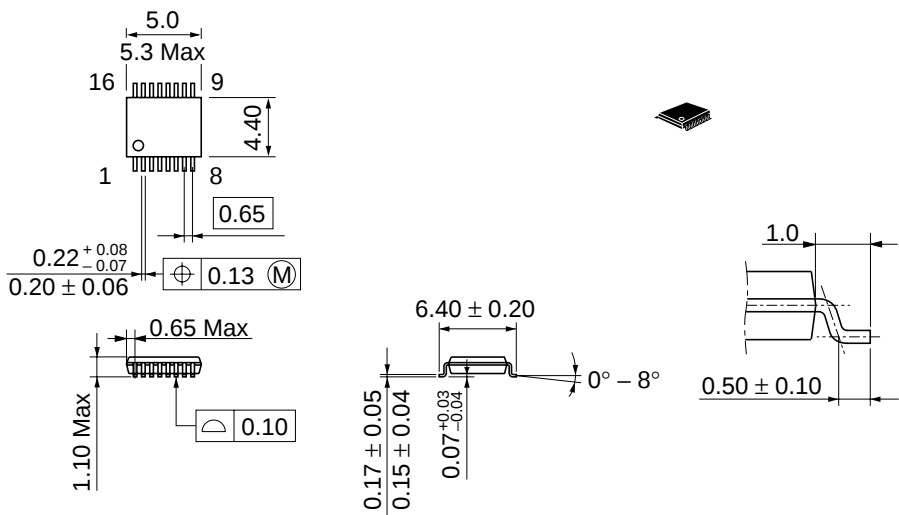
Hitachi Code	FP-16DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.24 g

Unit: mm



*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.15 g



Dimension including the plating thickness
Base material dimension

Hitachi Code	TTP-16DA
JEDEC	—
EIAJ	—
Weight (reference value)	0.05 g

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